



General Information

Series	SMD Auto X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade
RoHS	Yes
Termination	Tin
Typical Component Weight	105 mg
Shelf Life	78 Weeks

Dimensions

S	1.5mm MIN
Case Code (EIA / mm)	1210 / 3225

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

Specifications

Capacitance	0.18 uF
Tolerance	10%
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+150°C
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Insulation Resistance	5.5556 GOhms

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